UNITED STATES SECURITIES AND EXCHANGE COMMISSION

Washington, D.C. 20549

FORM 8-K

CURRENT REPORT
Pursuant to Section 13 or 15(d)
of the Securities Exchange Act of 1934

Date of Report (Date of earliest event reported): May 23, 2016 (May 17, 2016)

TTM TECHNOLOGIES, INC.

(Exact name of Registrant as specified in its charter)

Delaware (State of Incorporation) 0-31285 (Commission File Number) 91-1033443 (I.R.S. Employer Identification No.)

1665 Scenic Avenue, Suite 250, Costa Mesa, California 92626 (Address of Principal Executive Offices) (Zip Code)

> (714) 327-3000 Registrant's telephone number, including area code

N/A (Former name or former address, if changed since last report)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions:						
	Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)					
	Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)					
	Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))					
П	Pre-commencement communications pursuant to Rule 13e-4(c) under the Eychange Act (17 CER 240 13e-4(c))					

Section 7 - Regulation FD

Item 7.01. Regulation FD Disclosure.

On May 5, 2016, TTM Technologies, Inc. (the "Company") issued a press release announcing the participation of its management team in certain upcoming investor conferences, and its hosting of an "analyst day." As disclosed in the press release, the Company arranged for the simultaneous webcast of each event on the Company's website, and for a replay of each event to be accessible for a limited period of time. The Company also prepared an investor presentation for use (or portions thereof) at these events. Copies of the press release and a form of the investor presentation furnished as Exhibit 99.1 and Exhibit 99.2, respectively, to this Current Report on Form 8-K, and incorporated herein by reference solely for purposes of this Item 7.01 disclosure.

The information furnished in this Item 7.01, including Exhibit 99.1 and Exhibit 99.2 hereto, shall not be deemed "filed" for purposes of Section 18 of the Securities and Exchange Act of 1934, as amended (the "Exchange Act"), or otherwise subject to the liabilities of that section, unless the Company specifically states that the information is to be considered "filed" under the Exchange Act or incorporates it by reference into a filing under the Exchange Act or the Securities Act of 1933, as amended.

Section 9 - Financial Statements and Exhibits

Item 9.01. Financial Statements and Exhibits.

Exhibit 99.1 Press Release

Exhibit 99.2 Form of TTM Technologies, Inc. Investor Presentation

SIGNATURE

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

TTM TECHNOLOGIES, INC.

Date: May 23, 2016

/s/ Daniel J. Weber

By: Daniel J. Weber

Senior Vice President, General Counsel and Secretary

EXHIBIT INDEX

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99.2 Form of TTM Technologies, Inc. Investor Presentation

TTM Technologies, Inc.

Contact:
Sameer Desai,
Senior Director, Corporate
Development & Investor Relations
sameer.desai@ttmtech.com
714-327-3050

TTM TECHNOLOGIES, INC. ANNOUNCES UPCOMING CONFERENCE PARTICIPATION

Costa Mesa, CA – May 5, 2016 - TTM Technologies, Inc. (NASDAQ:TTMI), a leading global printed circuit board (PCB) manufacturer, today announced that members of its management team will present at the following investor conferences:

- The Stifel Technology, Internet & Media Conference in San Francisco at The Fairmont Hotel on Monday, June 6, 2016 at 4:45 PM Pacific Time; and
- · The Barclays High Yield Bond & Syndicated Loan Conference in Colorado Springs at The Broadmoor on Thursday, June 92016 at 10:10 AM Mountain Time.

The Company is also hosting an Analyst Day in New York at The Westin New York Grand Central on Tuesday, May 17, 2016 from 10:00 AM Eastern Time to 1:00 PM Eastern Time.

All presentations will be webcast live on the company's website, www.ttm.com, and a replay will be accessible for a limited time following the events.

About TTM

TTM Technologies, Inc. is a leading global printed circuit board manufacturer, focusing on quick-turn and technologically advanced PCBs, backplane assemblies and electromechanical solutions. TTM stands for time-to-market, representing how TTM's time-critical, one-stop manufacturing services enable customers to shorten the time required to develop new products and bring them to market. Additional information can be found at www.ttm.com.





[Date]

Agenda

[Specific Agenda to be included for each conference.]



Disclaimer

Forward-Looking Statements

Certain statements in this communication may constitute "forward-looking statements" within the meaning of the Private Securities Litigation Reform Act of 1995, including statements related to TTM's future business outlook. Actual results may differ materially from these forward-looking statements. Such statements relate to a variety of matters, including but not limited to: the operations of the businesses of TTM Technologies, Inc. ("TTM" or the "Company"). These statements are made on the basis of the current beliefs, expectations and assumptions of the management of TTM regarding future events and are subject to significant risks and uncertainty. Statements regarding our expected performance in the future are forward-looking statements.

It is uncertain whether any of the events anticipated by the forward-looking statements will transpire or occur, or if any of them do, what impact they will have on the results of operations and financial condition of the Company. These forward-looking statements involve certain risks and uncertainties that could cause actual results to differ materially from those indicated in such forward-looking statements and are set forth in the Company's most recent Annual Report on Form 10-K and Quarterly Report on Form 10-Q and in the Company's other filings filed with the Securities and Exchange Commission (the "SEC") under the heading "Risk Factors" and which are available at the SEC's website at www.sec.gov.

TTM does not undertake any obligation to update any of theses statements to reflect any new information, subsequent events or circumstances, or otherwise, except as may be required by law.

Use of Non-GAAP Financial Measures

In addition to the financial statements presented in accordance with U.S. GAAP, TTM uses certain non-GAAP financial measures, including "adjusted EBITDA." The companies present non-GAAP financial information to enable investors to see each company through the eyes of management and to provide better insight into its ongoing financial performance.

Adjusted EBITDA is defined as earnings before interest expense, income taxes, depreciation, amortization of intangibles, stock-based compensation expense, gain on sale of assets, asset impairments, restructuring, costs related to acquisitions, and other charges. For a reconciliation of adjusted EBITDA to net income, please see the appendix at the end of this presentation. Adjusted EBITDA is not a recognized financial measure under U.S. GAAP and does not purport to be an alternative to operating income or an indicator of operating performance. Adjusted EBITDA is presented to enhance an understanding of operating results and is not intended to represent cash flows or results of operations. The use of this non-GAAP measure provides an indication of each company's ability to service debt, and management considers it an appropriate measure to use because of the Company's leveraged positions.

Adjusted EBITDA has certain material limitations, primarily due to the exclusion of certain amounts that are material to each Company's consolidated results of operations, such as interest expense, income tax expense, and depreciation and amortization. In addition, adjusted EBITDA may differ from the adjusted EBITDA calculations reported by other companies in the industry, limiting its usefulness as a comparative measure.

Data Used in This Presentation

Due to rounding, numbers presented throughout this and other documents may not add up precisely to the totals provided and percentages may not precisely reflect the absolute figures.

Third Party Information

This presentation has been prepared by the Company and includes information from other sources believed by the Company to be reliable. No representation or warranty, express or implied, is made as to the fairness, accuracy or completeness of any of the opinions and conclusions set forth herein based on such information. This presentation may contain descriptions or summaries of certain documents and agreements, but such descriptions or summaries are qualified in their entirety by reference to the actual documents or agreements. Unless otherwise indicated, the information contained herein speaks only as of the date hereof and is subject to change, completion or amendment without notice.







Diversified, Differentiated and Disciplined Tom Edman

Key Messages

Diversification



- Diversified
- Near term Auto,
 Aerospace & Defense

Differentiation



- · Technology breadth
- · One stop solutions

Discipline



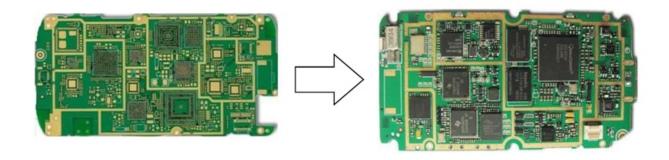
- · Disciplined integration
- · Cash flow generation





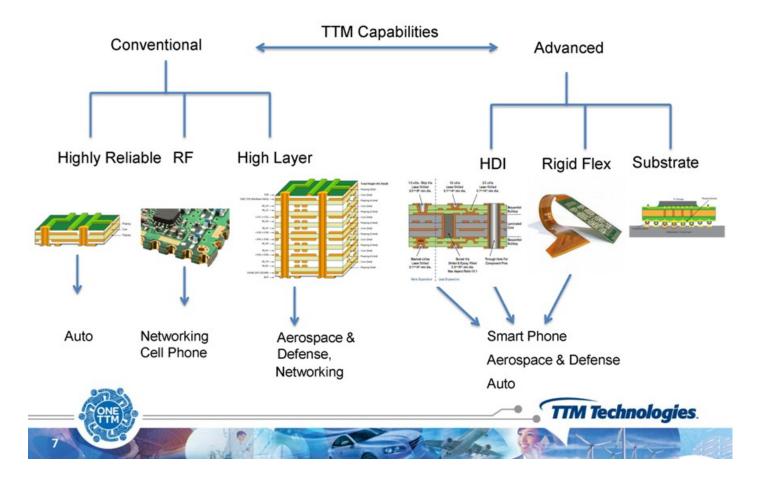
What is a PCB?

- · Building blocks for electronics
- Connects electronic components
- Customized for each end application





Different PCBs for Different Markets



PCBs: Foundation of all Electronics



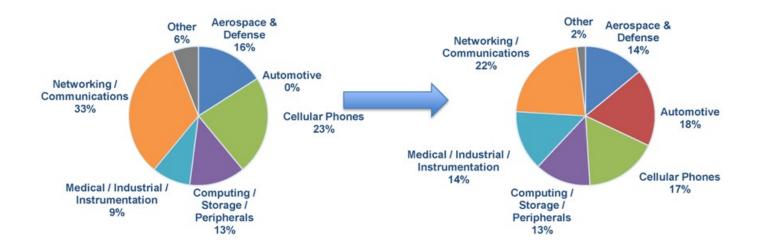


Message #1 – Diversification and Growth

Increasing End Market Diversification

2014 Revenue \$1,325 mm

2015 Pro Forma Revenue \$2,602 mm







Top Tier Customers





























End Market Growth Drivers

Aerospace & Defense

- Increased Commercial Air Traffic
- Increased Military Equipment Builds

2014-2019 CAGR





Automotive

- Electric Vehicle
- · Safety/ADAS/Infotainment

6-8%



Cell Phone

- · New Phone Functionality
- · Emerging Markets

5-8%



Computing

- Data Center Build
- IoT

5-8%



Networking/Telecom

- 4G/5G Infrastructure Spend
- Video Traffic

3-6%



Medical / Industrial/Instrumentation

- · Patient Monitoring
- ATE Upgrades

4-6%

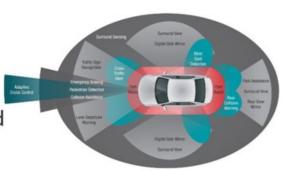


Sources: Prismark Partners May 2015, BPA March 2015, Electronic Outlook Corporation Q3 2015, Company estimates

TTM Technologies.

Automotive Opportunities

- Safety Advanced Driver Assist
 (ADAS) driving adoption of new technologies like Radar, IR, Ultrasound
- Electric Tighter emission standards driving EV/hybrid adoption
- Infotainment Video/Audio entertainment, internet access, connectivity





Key growth driver - Increasing electronic content





Aerospace & Defense Opportunities

- Aerospace seeing strong traffic growth
 - Continued rollout of Boeing 737 and 787 programs
- 2016 Defense budget up 5.8%
 - Missile Defense Agency awards New Long Range Discrimination Radar contract to Lockheed (\$784 M)
 - Navy awards Air and Missile Defense Radar to Raytheon
 - Joint Strike Fighter (JSF F35) DoD's largest planned procurement





Key growth drivers – Increasing traffic and procurements

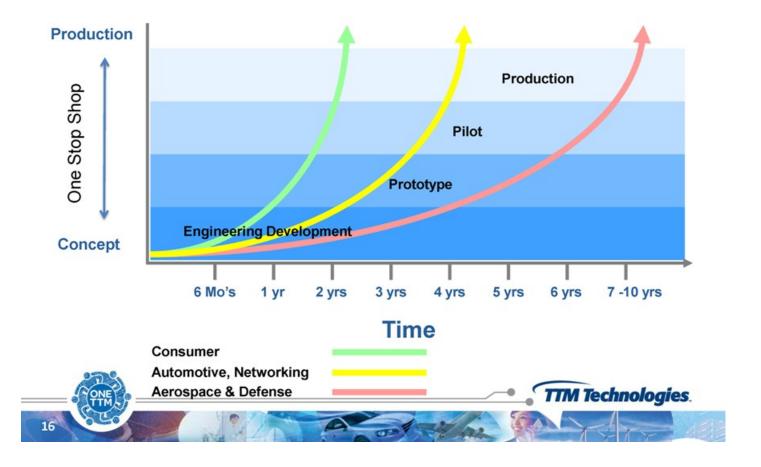






Message #2 - Differentiated through "One Stop Shop"

Customer Engagement Model



Global Footprint





5 Sterling - STE

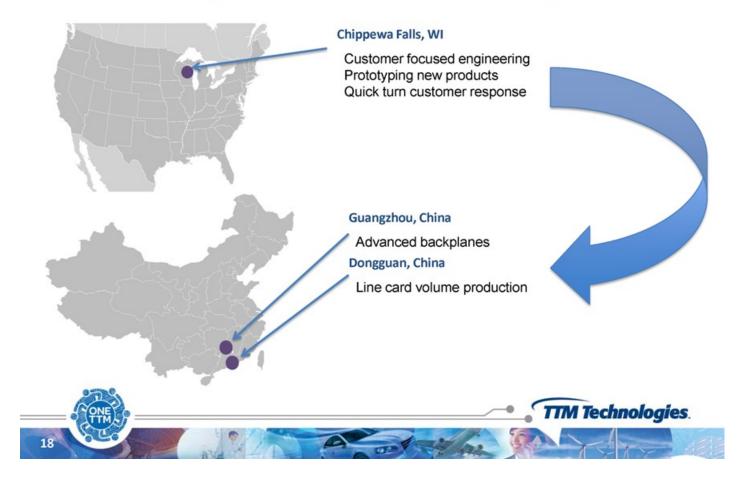
10 Santa Clara, SC



23 Guangzhou - GZ

19 Guangzhou - FPC

Global Footprint Meets Product Life Cycle Needs



Aligned with Technology Trends

End Device Trends

- Increasing complexity
- Decreasing size
- Increasing signal speed
- Increasing performance

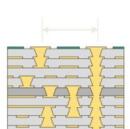


Increasingly Crowded PCBs

PCB Features

- Higher layer count
- Microvias
- innovations





Microvias

TTM Capabilities

- HDI
- **Rigid Flex**
- RF Radar

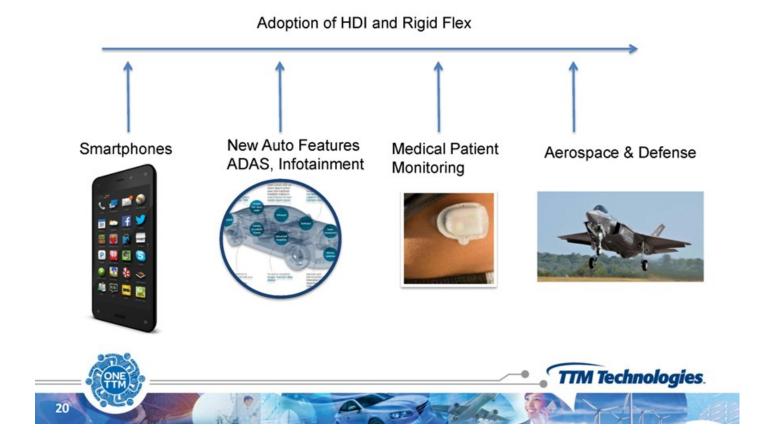


Laser Drills





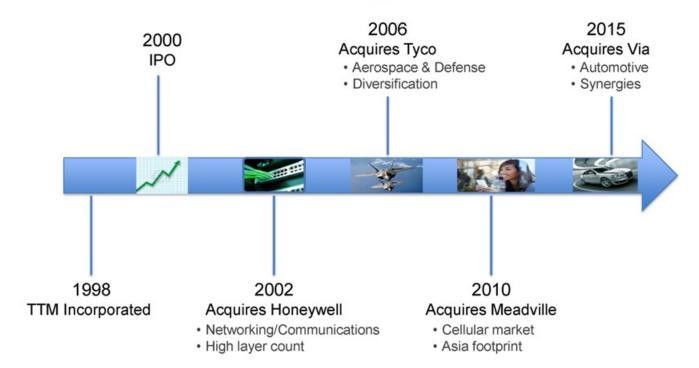
Leveraging New Technology in Smart Phones





Message #3 – Disciplined Integration & Deleveraging

Track Record of M&A Integration





Business Units and Leadership



Aerospace & Defense/Specialty

(A&D) Business Unit



Automotive & Medical, Industrial & Instrumentation

(AMI&I) Business Unit



Communications & Computing

(C&C) Business Unit



Electro-Mechanical Solutions

(E-MS) Business Unit

Phil Titterton Jon Pereira Doug Soder Tony Princiotta





Conclusions

- Diversified, near term opportunities in Auto, Aerospace & Defense
- Differentiated through "one stop shop"
- Disciplined M&A, Delivering solid cash flow











Communications and Computing Doug Soder

Value Proposition





Preferred Supplier

- Acknowledged Technology & Industry Leadership
- Proven customer track records



Advanced Technology

- High Layer Count Line Cards & Backplanes
- Advanced HDI
- Flex & Rigid-Flex circuits & assemblies
- Substrates



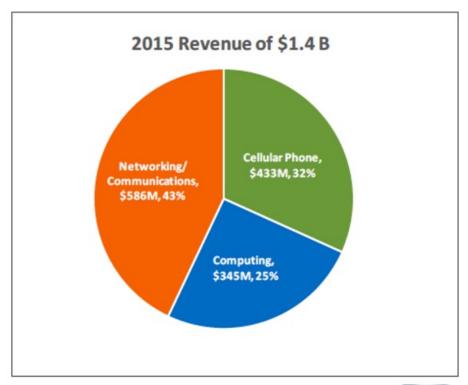
Full Product Life Cycle Solutions

- Engineering services for product concept & development
- Quick-turn & volume production
- Multi-plant global coordination





Balanced Markets & Diversification







Top Tier Networking & Communications Customers



Top Customers















Top Tier Cellular Phone Customers



Top Customers

Chengrui



SAMSUNG





Top Tier Computing Customers



Top Customers





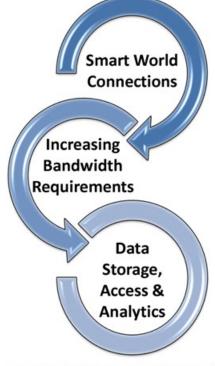








Mega Trends Drive Exciting Change & Opportunities



"By 2020, there will be 5.5B global mobile users & 11.6B mobile-ready devices & connections!"

"By 2020, average mobile connection speed will increase 3.2-fold & global mobile IP traffic will reach an annual run rate of 367 exabytes!"

"Big Data is growing at 40% annually!
By 2025, Global Data Traffic is said to cross
100 zettabytes (trillion GBs)!"

Dramatic Increases in Mobile Connections & Data Management!



Sources: 1.GSMA; 2. Forbes 2015 Roundup of Analytics, Big Data & Business Intellgience Forecast (May 25, 2015); 3.IDC



Networking & Communications

Growth Outlook – Networking & Communications





CAGR 14/19F: 3-6%





- Market Overview
 2015 Total PCB: \$6.0B
- TTM Focus
 - 4G-5G Base Stations & Radios
 - Core & Edge Routing
 - Optical Networking
 - Cloud Architecture Infrastructure

Sources: Prismark Partners May 2015, BPA March 2015, Electronic Outlook Corporation Q3 2015, Company estimates

TTM Technologies.



Success Story – Major Networking Customer

Global Account Management Model



Why WE Win:

- Broad-based Customer Engagement
- Technology Roadmap Collaboration
- Advanced Materials Expertise
- Multi-plant Global Solutions
- Operations Excellence







Cellular Phones

Growth Outlook - Cellular Phone +



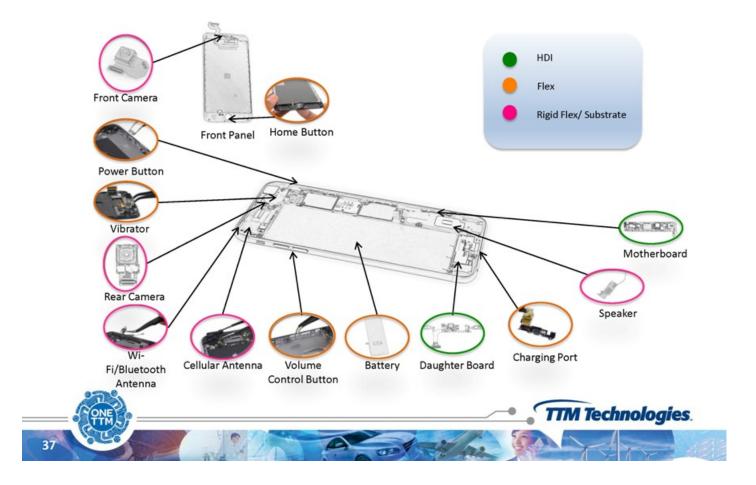
Overall market

2015 Total PCB Market

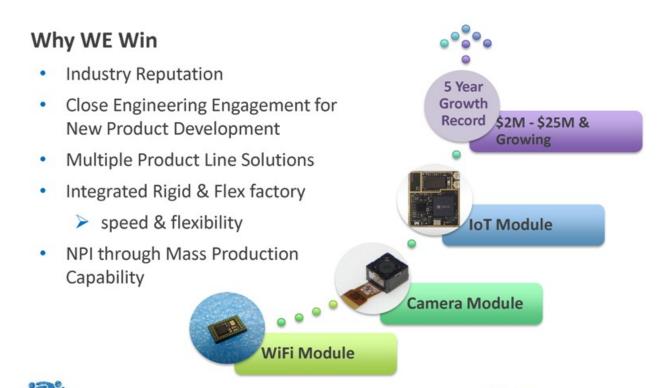
- Mobile Phones: \$9.6B
- Consumer \$5.0B
- Product focus areas
 - High end smartphones
 - Main boards
 - Battery modules
 - Camera modules
 - Wifi modules
 - Audio modules
 - Wearables



Growth Opportunities from Increasing Functionality



Success Story – Top Tier Smartphone OEM



TTM Technologies.

Communications & Computing Business Unit

Growth Opportunities

- Increasing Smartphone Functionality
- IoT / Wearables
- Cloud Infrastructure
- Service Provider Infrastructure









Electro-Mechanical Solutions Tony Princiotta

Value Proposition





PCB Pull Through

- E-MS help to sell higher margin PCBs
- More touch points increases program retention
- Cross selling possibilities



Customer Accountability

- One "Back to pat" or "Throat to choke"
- Long cycle programs



Boutique Player

- High mix, low to mid volume
- Large enough to be responsible, small enough to be responsive





TTM Technologies Advantage

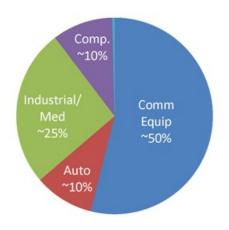


End to End Customer Solutions



Diversified with Increased Auto Focus in China

2015















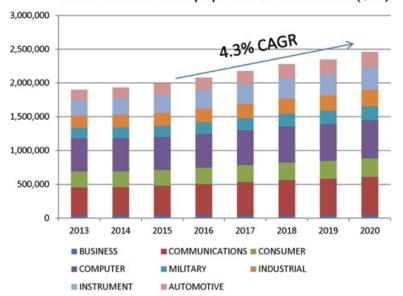
Market Segments

Top Tier Customers



Growth Opportunities

WW Electronic Equipment Production (\$M)



TTM Opportunities

- Asian Communication
 Infrastructure build out
- Electric Vehicles/ Energy Storage
- Industrial, Medical and Instrumentation segments

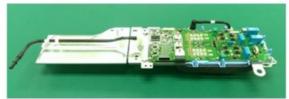
Source: Henderson Q1 2016





Success Story – Battery Management

- Major EV Automotive Manufacturer
- Why We Won
 - Existing PCB position
 - Customized process development
 - Industrial product built to Automotive Specifications
- Successful volume launch led to additional opportunities







Includes PCB, PCBA, Bus Bars, Custom Metal, Integration & Test





Success Story - Industrial

- 1.6 Megawatt Converter
- Why we won
 - Crisp manufacturing transition to China
 - Effective localization of the supply chain
 - Redesigned three separate enclosures to a single unit
- Success:
 - Delivered in excess of 10,000 units







Success Story - Transportation

- Locomotive Console
- Why We Won
 - Positive PCB reputation with parent company
 - Customer's desire to outsource console manufacturing to China
 - Strong vertical manufacturing competencies
 - Ability to work with incomplete documentation
- Success:
 - Prototypes delivered Q4, 2015
 Currently in production







TTM Technologies.



Conclusions

- E-M Solutions helps drive customer adoption of PCB products
- One stop shop that provides complete solutions increases "stickiness" to the customer and helps the PCB business retain core programs
- Growth opportunities in electric vehicles, optical transmission networks, industrial products





Aerospace & Defense / Specialty
Phil Titterton

Value Proposition



Superior reliability for mission critical applications



Multi-site solution to the military/aerospace community
All necessary certifications



One stop shop offering technology breadth and depth





Leading Player Alignment with Top Tier Customers





• #1 A&D PCB Manufacturer with 2015 Revenue ~\$350 million

Leading Player





Strategic Partnerships Strengthen Position

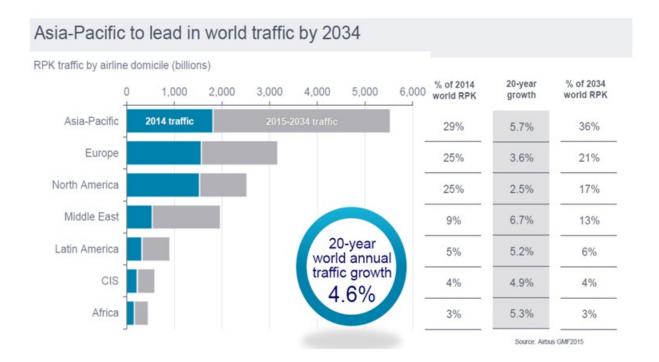
Customer	Years Partnered	Industry Sector(s)	
BAE SYSTEMS	25	Comm Aero & Defense	
DRS	17	Defense & Space	
HARRIS	18	Defense & Space	
Honeywell	29	Comm Aero, Defense & Space	
(B) communications	16	Comm Aero, Defense & Space	
LOCKHEED MARTIN	31	Defense & Space	
NORTHROP GRUMMAN	34	Defense & Space	
Raytheon	28	Defense & Space	
Rockwell Collins	20	Comm Aero, Defense & Space	
UTC Aerospace Systems	33	Comm Aero, Defense & Space	



Aerospace & Defense – Diverse Applications



Aerospace – Strong Commercial Traffic Driven by Asia







Key Opportunities in Commercial Aerospace

Commercial/Regional Airline Growth



- TTM supports flight critical electronics on 737, 777, 787, A319, A320, A321, A350, A380
- Fly by wire electrical content replacing traditional hydraulic systems







Aerospace Success Story



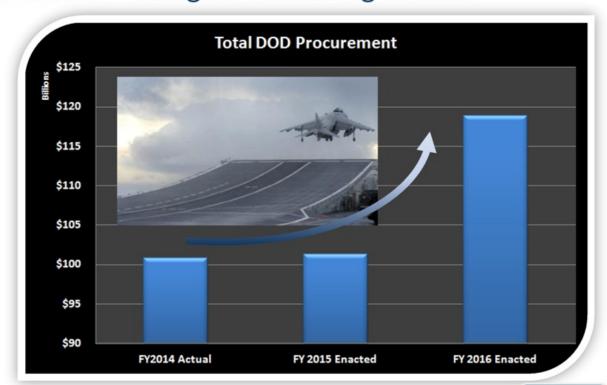
• Design through volume production capability

Why we win





Defense – Budgets Increasing in 2016



• DOD portfolio of 79 major defense acquisitions with total planned investment of \$1.44 trillion





Key Opportunities in Defense





• TTM supports mission critical electronics for a majority of DOD Programs including JSF, THADD, Patriot, F16, JDAM & Hellfire



1x APG-81 AESA





HARRIS

1x ELECTRONIC WAREFARE (EW) BAE SYSTEMS

Defense Success Story 1 – "One Stop Shop"



Space Fence

SUPPORTING FACILITIES	CAPABILITY
DESIGN ENGINEERING	Digital, RF, Flex
STAFFORD, CT	RF Structure
STAFFORD SPRINGS, CT	Flex Assembly
CHIPPEWA FALLS, WI	Digital PCB
SANTA CLARA, CA	Flex PCB
ANAHEIM, CA	HDI Interposer

- · Space Fence 100,000 debris tracking system down to size of baseball
- · Radar installation is equivalent to the size of a football field and is located on a South Pacific island
- Ability to meet all of customer's needs with multiple factory engagement capability vs. option of procuring from six different suppliers

Why we win





Defense Success Story 2 – "Mission Critical"



• Proven mission critical technology provider

Why we win









Automotive, Medical, Industrial and Instrumentation Jon Pereira

Value Proposition







ONE-STOP SOLUTION

WIDE-RANGE OF CAPABILITIES

TRUSTED HIGH
RELIABILITY SUPPLIER

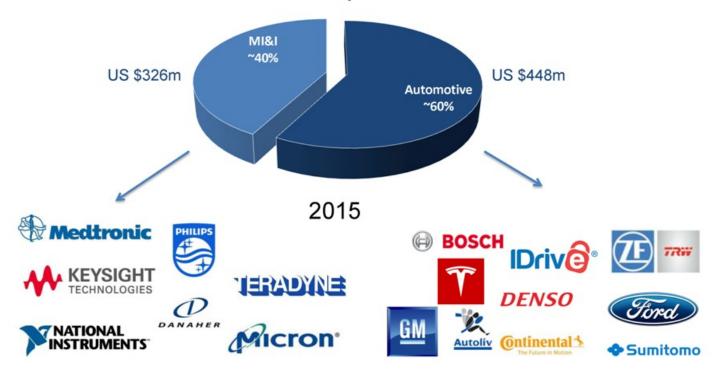
PROVEN TRACK RECORD SEAMLESS GLOBAL TRANSFER

FULL PRODUCT LIFE-CYCLE





Diverse Markets and Top Tier Customers







Automotive

Automotive Electronic Content Increasing



- Auto units expected to grow from 90M in 2015 to 110M in 2020
- Government regulations require advanced safety features
- Electric Vehicles growing with much higher PCB content
- China has only 100M cars vs US 300M
- PCB Avg. \$55/car growing to \$65 by 2020

	2025 2020					
	2015					
15\$	2010					
Thousands \$	2005					
SINC	2000					
Ĕ	1995				CAGR	:~3%
	1990					
	1985					
	1980					
		2015	2016	2017	2018	2019

Electronic Content/Vehicle

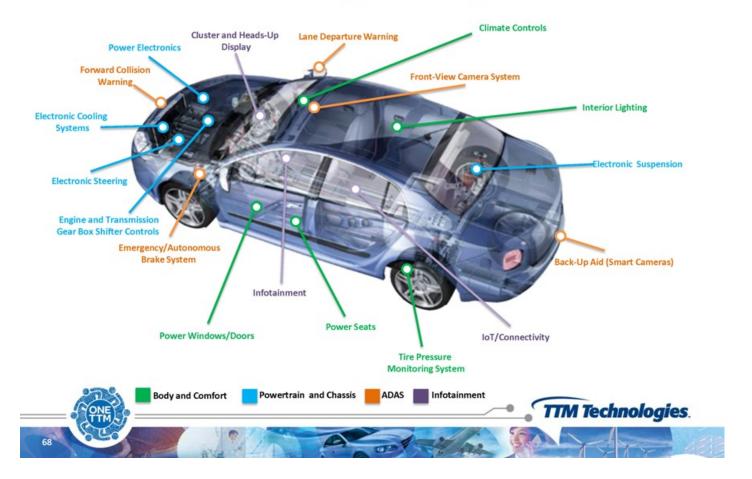
PCB Usage per Car							
Туре	Sq. Meter	USD	Volume				
Compact	0.3 - 0.4	18 – 30	~ 36.4				
Mid-Range	0.5 - 0.7	40 – 60	~ 56.4				
Luxury	2.0 – 3.0	120 - 150	~ 7.2				



Source: NTI Digest, October 2015



"Electrification" driving PCB Usage



Well Positioned for Emerging Trends

Key Opportunities

Connectivity • 12.2% CAGR

Autonomous Driving • 33% CAGR

Key Differentiators

- Extensive experience with passive safety, powertrain, body control, and chassis electronics
- Technology leader in HDI and rigid flex products
- **Expertise in manufacture of Radar products**







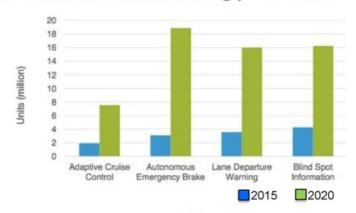


ADAS

• 27% CAGR

Emerging Market: Automotive Technology- Radar

Global automotive radar market size is estimated to exceed US \$5Billion by 2023 - Total radar sensor volume: - 2015 19 M units - 2020 70 M units







Source: Global Market Insights, March 2016

TTM Technologies.

Success Story: Autoliv



- · Multiple products including: Airbag, braking, Radar & camera
- New product launch 2016: 77Ghz (advanced radar detection)
- · Major Customers: GM, Hyundai, Honda, VW, Mercedes, & Chrysler
- · Designed in North America
 - o pre-production in North America;
 - seamless transfer to Asia
 Pacific for production

We won because TTM was able to offer a full-service solution, from concept to completion.



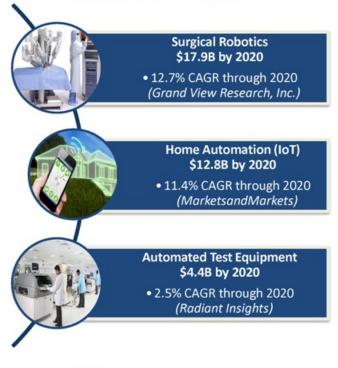






Medical, Industrial and Instrumentation

Growth Opportunities: Medical, Industrial & Instrumentation



- MII PCB Market Growth 4-5% CAGR 2015-2020
- Strength of product offering and technical expertise
- Growth for high reliability medical systems correlates to higher procedure rates and aging populations





TTM Technologies.

AMI&I Growth Opportunities

- Increasing Auto PCB content with focus on faster growing Electric Vehicles, ADAS, and Infotainment.
- In Medical, focus on surgical robotics and patient monitoring.
- In industrial, focus on automation, robotics, and home connectivity.



Why AMI&I Wins

- One Stop, Highly Customized, Global Solutions
- Trusted High-Reliability
 Supplier
- Proven Track Record with Top Automotive and Medical OEMs







Diversified, Disciplined and Deleveraging Todd Schull

Agenda

- Via Integration/Cost Improvement
- P&L Operating Model
- Cash Flow/Deleveraging Model



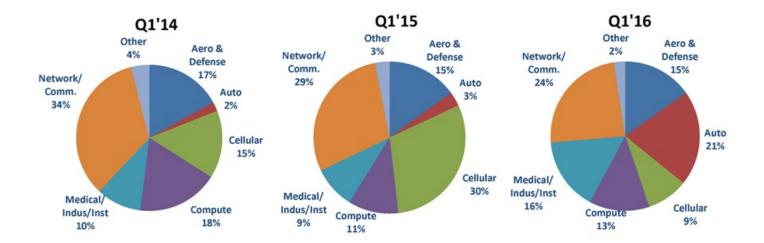
Via Integration Review

What we said last year

- ✓ Increased scale
- ✓ Increased auto exposure
- ✓ New BU operating model
- ✓ Expect \$55 million synergies by Q2 16
- ✓ Pay down debt



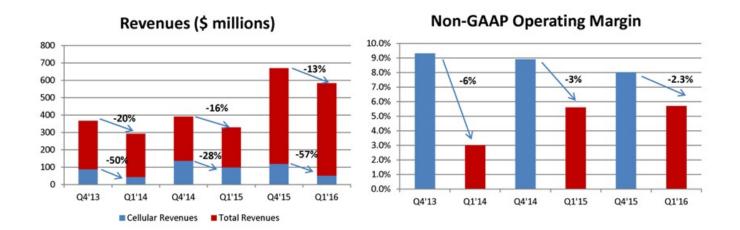
End Market Mix Past Three Years



Via reduced cellular, increased auto end market exposure



Diversification Reduces Volatility



Lower cellular exposure reduces Q1 revenue and OM decline



Disciplined M&A Integration



Improving margins and EPS despite declining revenues



Timeline of Via Synergies

Quarter	Value of Action	P&L Impact
Q2′15	\$6 million	
Q3′15	\$12 million	\$2.7 million
Q4'15	\$13 million	\$4.5 million
Q1'16	\$12 million	\$8 million
Q2′16E	\$12 million	\$11 million
Q3′16E		\$14 million
		x 4
Total	\$55 million	\$56 million



Post Via - Continuous Cost Improvement

- · Supply chain management
 - Alternate suppliers
 - Price reductions
- Best practice sharing
 - Materials usage reduction
 - Process improvement
- Margin improvement
 - Yield/Scrap improvement
 - Productivity improvement
- G&A efficiencies
 - Shared services
 - ERP





Model





Target 10% Non-GAAP operating margins for combined company



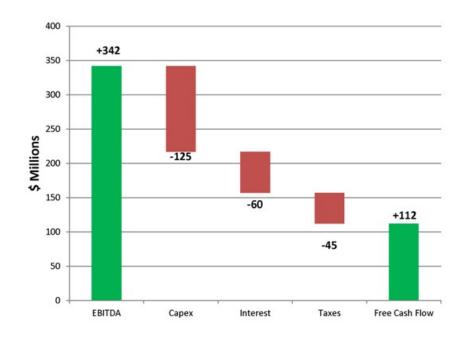
Key Outstanding Debt

- Term loan (\$871 million)
 - Issued (\$950 million) in conjunction with Via acquisition
 - Due May 31, 2021
 - Interest rate: Libor (1% floor) + 5% (6% currently)
 - Primary covenant leverage ratio <3.75
 - No pre-payment penalty
 - Repaid \$76.5 million in Q1'16
- Convertible (\$250 million)
 - Due Dec 15, 2020
 - Interest rate 1.75%
 - Conversion price \$9.64
 - Call spread strategy increases effective conversion price to \$14.26





Significant Cash Flow Generation Capability



- \$342 million pro-forma adjusted EBITDA in 2015
- Expected capex, interest and taxes
- Capex can be flex'd down
- Expected free cash flow \$100-\$120 million
- Target leverage ratio of 2.0

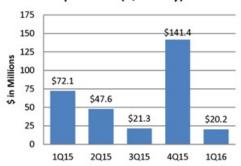
Hypothetical cash flow generation





Reported Cash Flows

Adjusted Cash Flows from Operations (Quarterly)



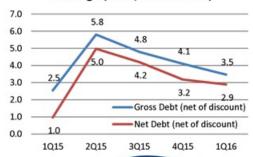
Adjusted Cash Flows from Operations (Annual)



Adjusted EBITDA



Leverage (Debt/LTM EBITDA)



TTM Technologies.

Future Priorities for Cash Flow Generation

- Generate Cash from Operations Grow Earnings
 - Execution
 - Synergies
- Generate Cash through Asset Efficiency
- Deleverage our Balance Sheet More Cash for Shareholders



Conclusions

- Successful Via integration Improved cost structure
- · Continuous focus on cost reduction and cash flow generation
- · Solid cash flow capability for deleveraging





Thank You

Reconciliations

Millions (except where noted)	Q1 2015	Q2 2015	Q3 2015	Q4 2015	Q1 201
AAP Gross Profit	\$51.6	\$61.2	\$89.1	\$108.3	\$83.
dd back items:					
Inventory markup and PP&E step up		7.4	8.2	0.6	
Stock-based compensation	0.2	0.2	0.3	0.3	0.3
on-GAAP Gross Profit	51.8	68.8	97.7	109.2	83.
AAP Operating Income (Loss)	8.3	(7.1)	23.6	36.5	18.
dd back items:					
Amortization of intangibles	1.9	3.9	6.4	6.7	5.
Stock-based compensation	2.0	2.3	2.7	2.6	2.
Gain on sale of assets	(2.5)	-		-	-
Acquisition-related costs	8.2	22.6	2.1	1.5	0.
Inventory markup and PP&E step up	-	7.4	8.2	0.6	-
Impairments and restructuring charges	0.5	0.1	2.0	5.4	5
on-GAAP Operating Income	18.4	29.2	45.0	53.4	33
AP TTM Technologies Net Income (Loss) Id back items:	3.4	(36.6)	(2.2)	9.5	(7
Amortization of intangibles	1.9	3.9	6.4	6.7	5
Stock-based compensation	2.0	2.3	2.7	2.6	2
Non-cash interest expense	2.6	3.3	4.8	4.9	é
Gain on sale of assets	(2.5)	5.5	4.0	4.0	
Acquisition-related costs	8.2	22.6	2.1	1.5	C
Inventory markup and PP&E step up	0.2	7.4	8.2	0.6	
Impairments, restructuring and other infrequent items	0.6	0.9	2.0	5.4	5
Income taxes	(5.4)	11.1	(0.1)	0.3	Č
on-GAAP TTM Technologies Net Income	10.8	14.9	23.8	31.5	13
on-GAAP EPS (\$ per diluted share)	\$0.13	\$0.17	\$0.24	\$0.31	\$0.
AAP Net Income (Loss)	3.4	(36.6)	(2.1)	9.7	(7
dd back items:					
Income tax provision (benefit)	(1.4)	16.6	8.7	10.6	5
Interest expense	5.8	12.8	21.0	20.2	21
Amortization of intangibles	1.9	3.9	6.4	6.7	5
Depreciation expense	24.5	29.8	40.1	39.1	40
Stock-based compensation	2.0	2.3	2.7	2.6	- 2
Sain on sale of assets	(2.5)				
Acquisition-related costs	8.2	22.6	2.1	1.5	(
nventory markup		7.4	6.8		
mpairments, restructuring and other infrequent items	0.6	0.9	2.0	5.4	
justed EBITDA	42.5	59.7	87.6	95.8	74
erating Cash Flow d back items:	67.4	15.5	14.7	139.8	17
Payment of accreted interest on convertible sr. notes		8.7			
Payment of acquisition-related costs	4.7	23.4	6.6	1.5	2
djusted Operating Cash Flow	72.1	47.6	21.3	141.4	20

Reconciliations

\$ Millions (except where noted)	2012	2013	2014	2015
GAAP Gross Profit	\$225.0	\$217.8	\$194.7	\$310.1
Inventory markup and PP&E step up				16.2
Stock-based compensation	1.1	1.1	0.9	1.1
Ion-GAAP Gross Profit	226.1	218.9	195.6	327.5
SAAP Operating Income (Loss)	(142.0)	69.1	46.5	61.3
dd back items: Amortization of intangibles	14.7	9.4	8.4	18.9
Stock-based compensation	10.3	9.0	7.8	9.7
Impairment and restructuring	218.4	14.2	1.9	7.9
Inventory markup and PP&E step up	210.4	14.2		16.2
Other infrequent items	-	(17.9)	6.0	32.0
on-GAAP Operating Income	101.4	83.8	70.6	146.0
GAAP TTM Technologies Net Income (Loss) Add back items:	(174.6)	21.9	14.7	(25.9)
Amortization of intangibles	14.7	9.4	8.4	18.9
Stock-based compensation	10.3	9.0	7.8	9.7
Non-cash interest expense	7.9	8.4	10.2	15.6
Impairment and restructuring	218.4	14.2	1.9	8.7
Inventory markup and FP&E step up	-			16.2
Other infrequent items	5.5	(7.2)	6.5	32.0
Income tax effects	(12.4)	(4.4)	(10.2)	5.9
on-GAAP TTM Technologies Net Income	69.8	51.3	39.3	81.1
on-GAAP EPS (\$ per diluted share)	0.85	0.62	0.47	0.87
GAAP Net Income (Loss)	(181.1)	23.9	14.7	(25.6)
dd back items: Income tax provision	12.7	15.9	7.6	34.6
Interest expense	25.8	24.0	23.8	59.8
Amortization of intangibles	14.7	9.4	8.4	18.9
Depreciation expense	84.3	92.1	95.3	133.5
Stock-based compensation	10.3	9.0	7.8	9.7
Gain on sale of assets	-	(17.9)		(2.5)
Inventory markup		-		14.2
Impairments, restructuring and other infrequent items	223.9	24.9	8.4	43.1
djusted EBITDA	190.6	181.3	166.0	285.7
perating Cash Flow	182.6	71.4	129.8	237.5
dd back items: Payment of accreted interest on convertible senior notes		27.7	1,3	8.7
Payment of acquisition-related costs		21.1	2.1	36.2
Adjusted Operating Cash Flow	182.6	99.1	133.2	282.4
Adjusted Operating Casil Flow	102.0	00.1	100.2	202.4



